

Legacy Device: Motorola MC12079

The ML12079 is a single modulus divide by 64, 128, 256 prescaler for low power frequency division of a 2.8 GHz (typical) high frequency input signal. Divide ratio control inputs SW1 and SW2 select the required divide ratio of ÷64, ÷128, or ÷256.

An external load resistor is required to terminate the output. A 1.2 kΩ resistor is recommended to achieve a 1.6 V_{pp} output swing, when dividing a 1.1 GHz input signal by the minimum divide ratio of 64, assuming a 12 pF load. Output current can be minimized dependent on conditions such as output frequency, capacitive load being driven, and output voltage swing required. Typical values for load resistors are included in the V_{Out} specification for various divide ratios at 2.8 GHz input frequency.

- 2.8 GHz Toggle Frequency
- Supply Voltage 4.5 to 5.5 V
- Low Supply Current 9mA Typical at V_{CC} = 5.0 V
- Operating Temperature Range of T_A = -40 to 85°C

FUNCTIONAL TABLE

SW1	SW2	Divide Ratio
H	H	64
H	L	128
L	H	128
L	L	256

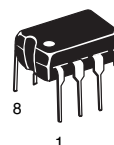
NOTE: SW1 & SW2: H = V_{CC}, L = Open.

MAXIMUM RATINGS

Characteristic	Symbol	Range	Unit
Power Supply Voltage, Pin 2	V _{CC}	-0.5 to 7.0	Vdc
Operating Temperature Range	T _A	-40 to 85	°C
Storage Temperature Range	T _{stg}	-65 to 150	°C
Maximum Output Current, Pin 4	I _O	4.0	mA



SO 8 = -5P
PLASTIC PACKAGE
CASE 751



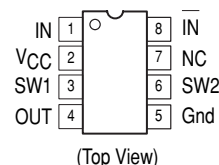
P DIP 8 = PP
PLASTIC PACKAGE
CASE 626

CROSS REFERENCE/ORDERING INFORMATION

PACKAGE	MOTOROLA	LANSDALE
P DIP 8	MC12079P	ML12079PP
SO 8	MC12079D	ML12079-5P

Note: Lansdale lead free (Pb) product, as it becomes available, will be identified by a part number prefix change from **ML** to **MLE**.

PIN CONNECTIONS



ELECTRICAL CHARACTERISTICS ($V_{CC} = 4.5$ to 5.5 V; $T_A = -40$ to 85°C , unless otherwise noted.)

Parameter	Symbol	Min	Typ	Max	Unit
Toggle Frequency (Sine Wave)	ft	0.25	3.4	2.8	GHz
Supply Current Output (Pin 2)	I _{CC}	–	9.0	11.5	mA
Input Voltage Sensitivity 250–500 MHz 500–2800 MHz	V _{in}	400 100	– –	1000 1000	mV _{pp}
Divide Ratio Control Input High (SW)	V _{IH}	V _{CC}	V _{CC}	V _{CC}	V
Divide Ratio Control Input Low (SW)	V _{IL}	Open	Open	Open	–
Output Voltage Swing (C _L = 12 pF; R _L = 1.2 kΩ; I _O = 2.7 mA) ¹ (C _L = 12 pF; R _L = 2.2 kΩ; I _O = 1.5 mA) ² (C _L = 12 pF; R _L = 3.9 kΩ; I _O = 0.85 mA) ³	V _{out}	1.0	1.6	–	V _{pp}

NOTES: 1. Divide ratio of $\div 64$ at 2.8 GHz.
2. Divide ratio of $\div 128$ at 2.8 GHz.
3. Divide ratio of $\div 256$ at 2.8 GHz.

Figure 1. Logic Diagram (ML12079)

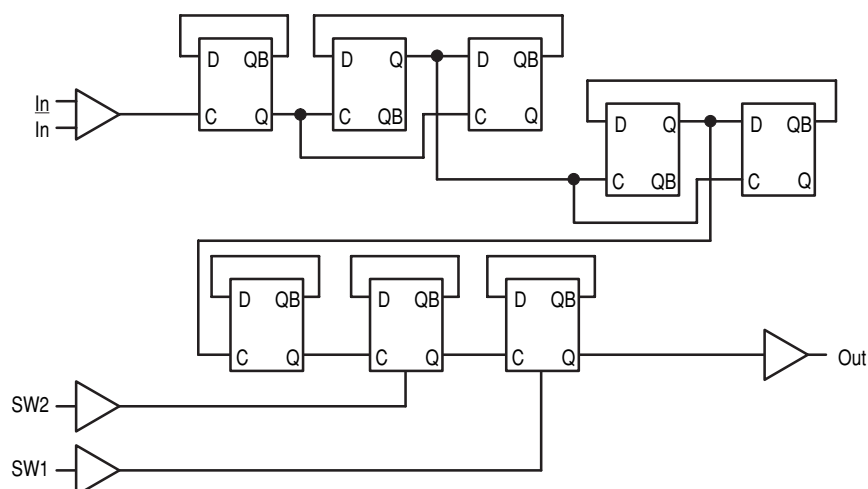


Figure 2. AC Test Circuit

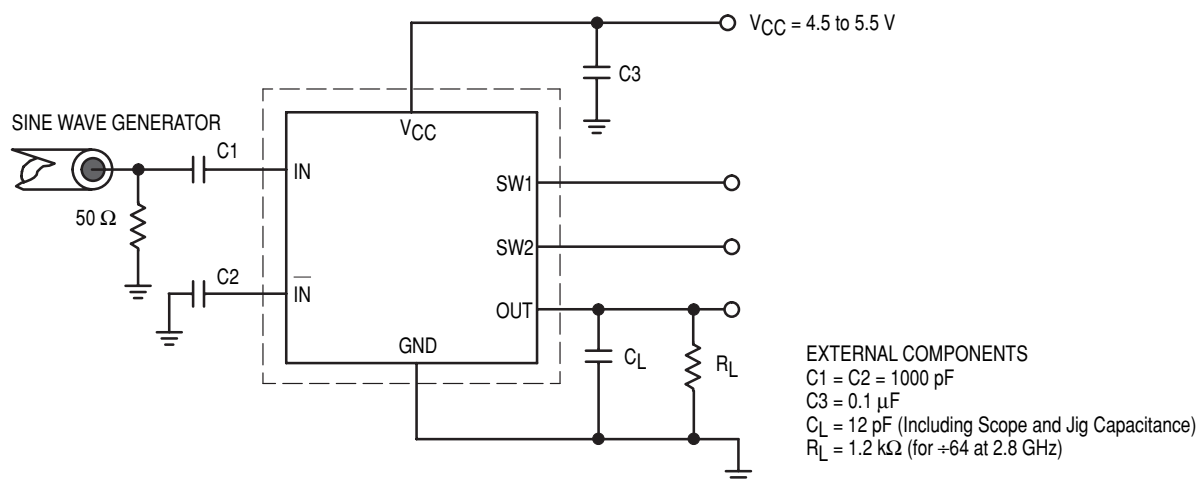


Figure 3. Input Signal Amplitude versus Input Frequency

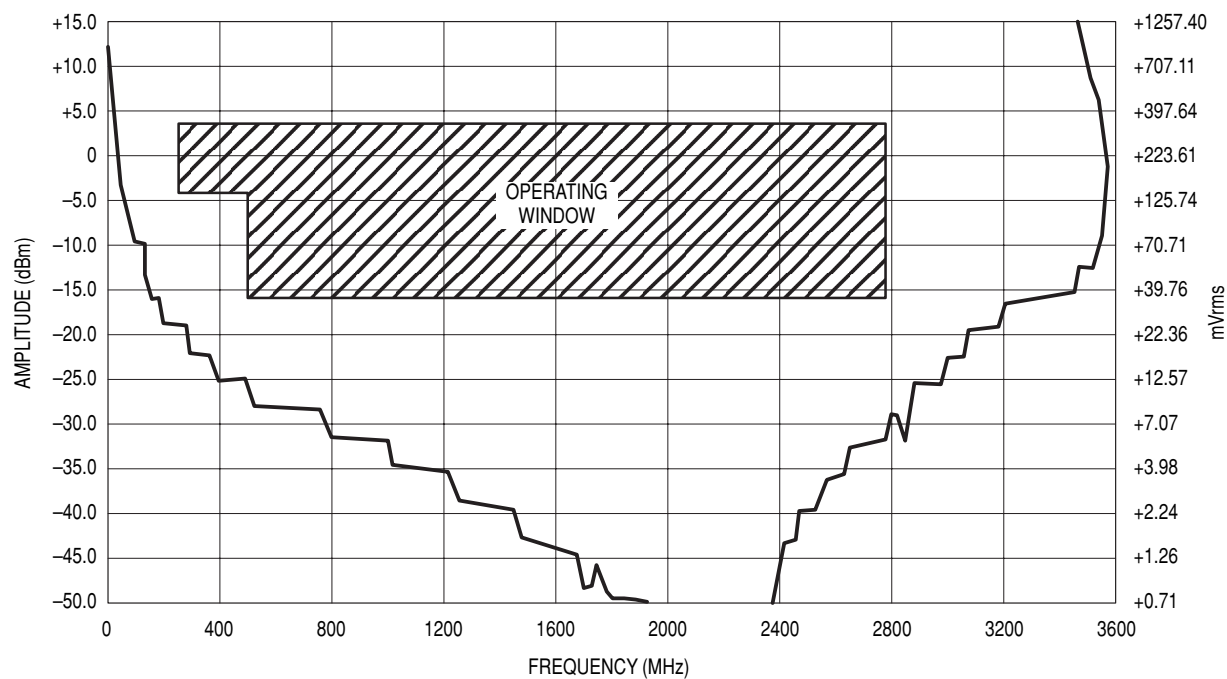
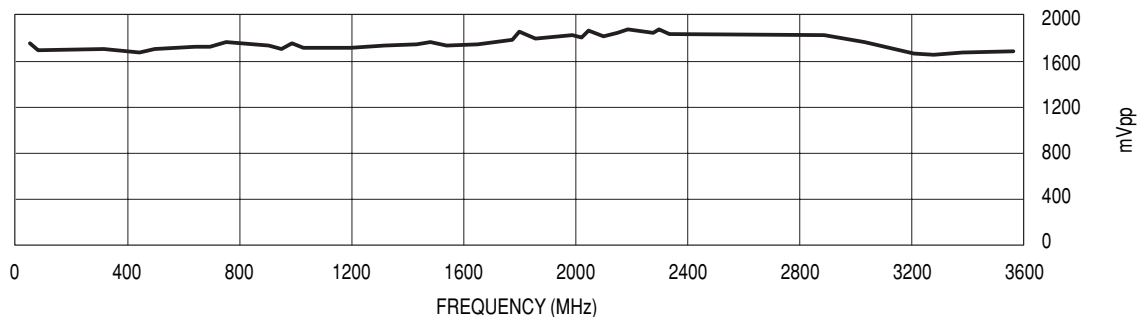
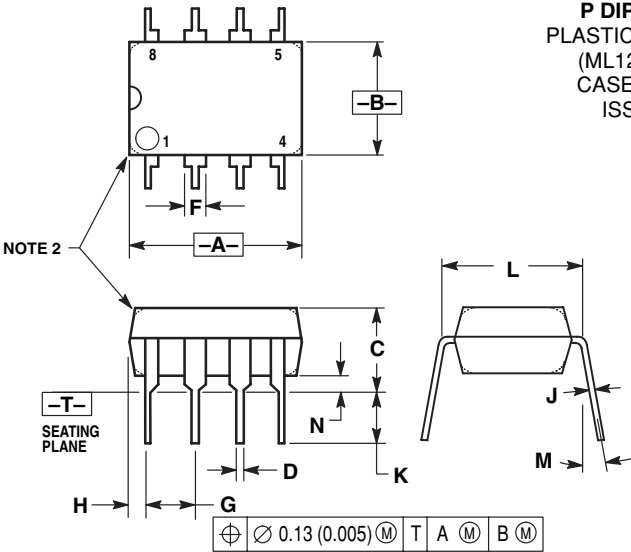
Divide Ratio = 64; $V_{CC} = 5.0 \text{ V}$; $T_A = 25^\circ\text{C}$

Figure 4. Output Amplitude versus Input Frequency

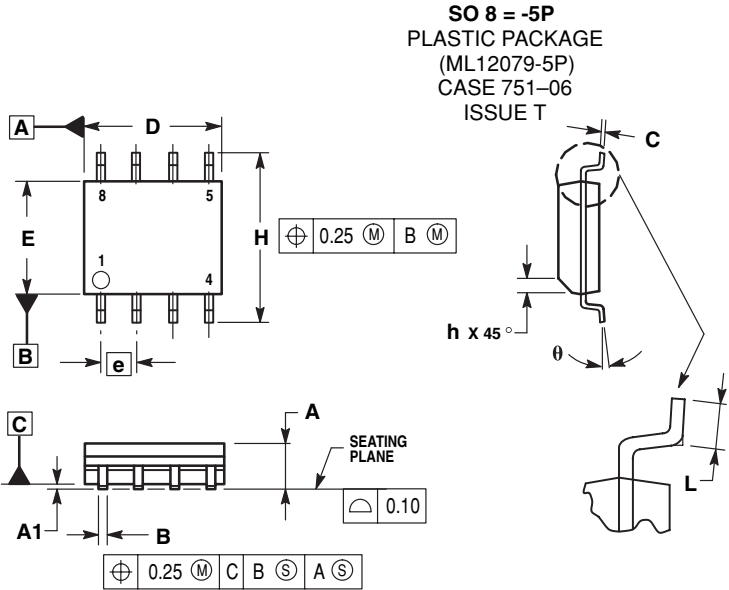


OUTLINE DIMENSIONS



- NOTES:
- 1. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 - 2. PACKAGE CONTOUR OPTIONAL (ROUND OR SQUARE CORNERS).
 - 3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	10.16	0.370	0.400
B	6.10	6.60	0.240	0.260
C	3.94	4.45	0.155	0.175
D	0.38	0.51	0.015	0.020
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	0.76	1.27	0.030	0.050
J	0.20	0.30	0.008	0.012
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	10°		10°	
N	0.76	1.01	0.030	0.040



- NOTES:
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 - 2. DIMENSIONS ARE IN MILLIMETER.
 - 3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTRUSION.
 - 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 - 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.25
θ	0°	7°

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